1-2349201-9 ACTIVE

SFP56

TE Internal #: 1-2349201-9

zSFP+ Stacked (SFP56), Cage Assembly with Integrated Connector,

.6mm [.018in] Centerline, Signal

View on TE.com >

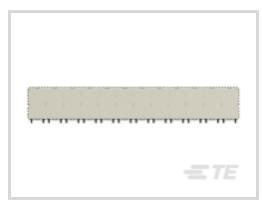


Connectors > Pluggable IO Connectors & Cages > SFP56 Stacked Cage Assembly: EMI Spring











Form Factor: zSFP+ Stacked (SFP56)

Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Centerline (Pitch): .6 mm [.018 in]

Circuit Application: Signal

Operating Temperature Range: -55 – 105 °C [-67 – 221 °F]

All SFP56 Stacked Cage Assembly: EMI Spring (48)

Features

Termination Features

Termination Method to PCB	Through Hole - Press-Fit
Operation/Application	
Pluggable I/O Applications	SFP28
Circuit Application	Signal
Product Type Features	
Cage Type	Stacked
Form Factor	zSFP+ Stacked (SFP56)
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Configuration Features	
Number of Positions	20
Number of Ports	24
Port Matrix Configuration	2 x 12



Data Rate (Max)	56 Gb/s
Housing Features	
Centerline (Pitch)	.6 mm[.018 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Other	
Included Lightpipe	Yes
EMI Containment Feature Type	Internal/External EMI Springs
EU RoHS Compliance	Compliant

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

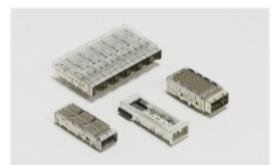




Also in the Series | SFP56



Pluggable I/O Cable Assemblies(17)



Pluggable IO Connectors & Cages(53)



SFP, SFP+ & zSFP+(53)

Customers Also Bought



TE Part #2349202-5 SFP56 STACKED 2X1 RECEPTACLE ASSEMBLY



TE Part #6-2213362-2 RCPT ASSY,DIMMABLE PHOTOCONTROL,150C,3 P



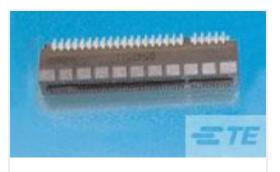
TE Part #2132529-3 IMP100S,H,V3P6C,LG,REW39,5.5



TE Part #5-1375870-4 RCPT ASSY,12 POS,VERT,0.8MM MI



TE Part #2-6450880-4 MBXLE R/A RCPT 4P16S4P



TE Part #1-1871058-5
PCI EXPRESS CONN. EON TYPE,
280P, L=3.25



TE Part #1734100-3 Champ050 series,30pos,Au over PdNi



TE Part #1734101-3 Champ050 series,30pos,Au over PdNi









Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2349201-9_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2349201-9_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2349201-9_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English